C	Material Composit Copyright 2005. IPC, F nternational and Pan-Am	Bannockbu	ırn, Illinois. A	ll rights reserved a	under both	This docum level parts, t	ent is a decla he declaratio	ration of n encom	f the substances	s within the manufact er level materials for	urer listed which the	item. Note: manufactur	if the item is an as er has engineering	ssembly with lower responsibility.	
					Form Type Distribute						erials and N	ials and Mfg Information			
Supplier Information	on														
Company name*			Company unique ID				Unique ID Authority				Respor	Response Date*			
onsemi											2024-0	2024-05-11			
Contact Name			Title - Contact				Phone - Contact*				Email ·	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA			Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*			Email ·	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Ite	Requester Item Number Mfr Iter		n Number Mfr Item Name				Effective D	ate Ve	ersion	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP136CFCT120T2G 700 mA, Very Low CMOS Voltage Re		ow Dropout Bias Regulator, Slow s	Rail slew rate	2024-05-11		CNQ			0.736	mg	Each		
Manufacturing Pro	occess Information														
Terminal Plati	Terminal Plating / Grid Array Material T		Cerminal Base Alloy J-STD		J-STD-020 MSL	Rating	Peak P	Peak Process Body Temperatu		ure Max Time at Peak Tempera		ture Num	nber of Reflow Cy	cles	
Matte Tin (Sn) - annealed			CU Alloy 1			260 C 30		seconds 3							
Comments															
level 1 - maximum time	at peak temperature d	uring sold	lering is 10-3	0 seconds											
For more information re	egarding material com	position p	lease refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Bump	0.063	mg	Supplier	Tin (Sn)	7440-31-5		0.0448	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0182	mg	
Die	0.655	mg	Supplier	Silicon (Si)	7440-21-3		0.655	mg	
Protection coat	0.017	mg		Polyimide	proprietary data		0.017	mg	
Under Bump Metal	0.001	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0009	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3